



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Kie Y. Ahn et al.

Title:

SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Attorney Docket No.: 303.672US1

## PATENT APPLICATION TRANSMITTAL

## BOX PATENT APPLICATION

Assistant Commissioner for Patents

Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

- Utility Patent Application under 37 CFR § 1.53(b) comprising: X
  - Specification (37 pgs, including claims numbered 1 through 64 and a 1 page Abstract).
- Formal Drawing(s) ( \_7\_ sheets). X
- Signed Declaration (<u>6</u>pgs).
- Assignment of the invention to Micron Technology, Inc. ( 3 pgs) and Recordation Form Cover Sheet.
- Return postcard.

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	64 - 20 =	44	x 18 =	\$792.00
INDEPENDENT CLAIMS	12 - 3 =	9	x 78 =	\$702.00
MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$690.00
	TOTAL		•	\$2,184.00

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Date of Deposit: January 18, 2000 "Express Mail" mailing label number: <u>EL517793206US</u> I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Pox Patent Application, Washington, D.C. 20231.

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